Revealing the Synergistic Effect of LiF and Li₃N in Solid Electrolyte Interphase for Stable Lithium Metal batteries via In-Situ Electrochemical Atomic Force Microscope

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Figure S1. Voltage capacity profiles of different cycles for plating capacities of 2.0 mAh cm⁻² in different electrolytes.



Figure S2. Top view (a-b) and cross view (b) SEM images of Li metal deposited at 1.0 mA cm^{-2} for 2 h (2.0 mAh cm⁻²) after plating in pure electrolyte.



Figure S3. SEM images of Li metal deposited at 1.0 mA cm⁻² for 2 h (2.0 mAh cm⁻²) after plating in FEC electrolyte with low magnifications.



Figure S4. SEM images of Li metal deposited at 1.0 mA cm⁻² for 2 h (2.0 mAh cm⁻²) after plating in LiNO₃ electrolyte with low magnifications.



Figure S5. SEM images of Li metal deposited at 1.0 mA cm⁻² for 2 h (2.0 mAh cm⁻²) after plating in FEC-LiNO₃ electrolyte with low magnifications.



Figure S6. XPS Li 1s depth profiles of the SEIs after Li plating and stripping process in pure electrolyte.



Figure S7. XPS C 1s depth profiles of the SEIs after Li plating and stripping process in pure electrolyte (a, e), FEC electrolyte (b, f), $LiNO_3$ electrolyte (c, g) and FEC-LiNO₃ electrolyte (d, h) with different depth of SEIs due to Ar⁺ sputtering (0s, 30s, 60s, 180s and 360s).



Figure S8. XPS F 1s depth profiles of the SEIs after Li plating and stripping process in FEC electrolyte (a, c) and FEC-LiNO₃ electrolyte (b, d) with different depth of SEIs due to Ar^+ sputtering (0s, 30s, 60s, 180s and 360s).



Figure S9. AFM and modulus images of SEI on Li metal after plating at 1.0 mA cm^{-2} for 2 h (2.0 mAh cm⁻²) and stripping to 1V in pure electrolyte.



Figure S10. The LSV curve between 0-1.0 V at a scan rate of 0.1 mVs⁻¹.



Figure S11. In situ AFM images of Li metal nucleation and growth. Morphology of the Cu foil during galvanostatic discharge at 1.0 mA cm⁻² for 18 s (0.005 mAh cm⁻²), 72 s (0.02 mAh cm⁻²), 180 s (0.05 mAh cm⁻²) and 1080 s (0.3 mAh cm⁻²) in pure LiBOB-based electrolyte without any LiNO₃ or FEC additives.



Figure S12. The corresponding height curves in corresponding to the marked regions in Figure S11b in pure LiBOB-based electrolyte without any LiNO₃ or FEC additives.